

DRD7 Structure

Frank Simon

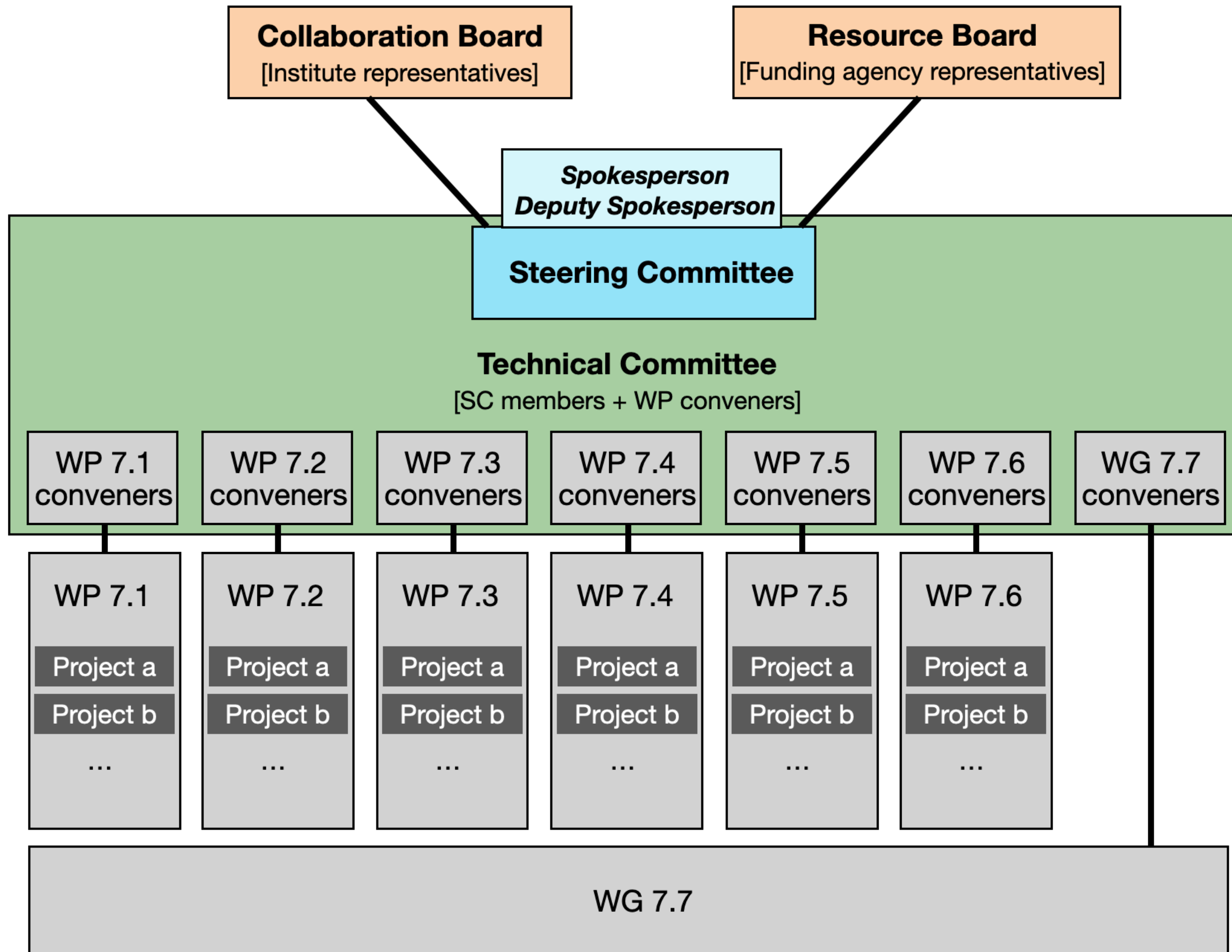
KIT Institute for Data Processing and Electronics

on behalf of the DRD7 Steering Committee

DRD7 Collaboration Meeting, CERN, 09.09.2024

The Collaboration Structure

Adapted to the Community



- R&D in electronics often revolves around major laboratories that can provide a backbone of expertise (in particular engineering) and resources (production, expensive hardware). Reflected in composition of **Steering Committee** as central executive body.
- Research activities defined bottom-up by institutes coming together in **Projects**, grouped thematically in **Work Packages**. WG conveners as coordinators, facilitators of information exchange within WP, within DRD7, and with observing parties from other backgrounds and other DRDs.
One transversal **Working Group**.

NB: Nomenclature may still to be adjusted to achieve uniformity across DRDs.

The Collaboration Board

Composition of the Collaboration

- One representative per contributing institution
- Chaired by a chairperson, elected from CB members
- Appoints SC members, endorses Spokesperson, Co-Spokesperson and WP/WG Conveners nominated by SC
- 68 institutions from 19 countries (incl. CERN)

Member institutes are institutes that are active in at least one project (e.g. with a concrete FTE commitment)

Several additional institutes have shown interest in projects, but have not yet formally joined. These institutes are invited to subscribe to the *observers list*, and will be informed about events related to the WG subscribed to, and about general DRD7 events.

Country	Institute	Email address
AT	Graz University of Technology, Institute of Electronics	alicja.michalowska@tugraz.at
BE	KU Leuven	levi.marien@kuleuven.be
CA	Sherbrooke University	serge.charlebois@usherbrooke.ca
Cern	CERN	francois.vasey@cern.ch
CH	EPFL	edoardo.charbon@epfl.ch
	University of Geneva, DPNC	anna.sfyria@cern.ch
DE	Bergische Universitaet Wuppertal	wagner@uni-wuppertal.de
	Deutsches Elektronen-Synchrotron (DESY)	christian.reckleben@desy.de
	Fachhochschule Dortmund	michael.karagounis@fh-dortmund.de
	Forschungszentrum Jülich	A.Zambanini@fz-juelich.de
	Karlsruhe Institute of Technology (KIT)	frank.simon@kit.edu
	MPG HLL	lca@hll.mpg.de
	RWTH Aachen University, Physics Institute IB	feld@physik.rwth-aachen.de
EE	Tallinn University of Technology (TalTech)	andrii.chub@taltech.ee
ES	Centre for Energy, Environmental and Technological Research (CIEMAT)	cristina.fernandez@ciemat.es
	Galician Institute of High Energy Physics (IGFAE)	antonio.fernandez.prieto@cern.ch
	Instituto de Fisica Corpuscular (IFIC) Valencia	Arantza.Oyanguren@ific.uv.es
	Instituto de Fisica de Cantabria (IFCA)	ivan.vila@csic.es
	Instituto de Microelectrónica de Barcelona (IMB-CNM)	miguel.ullan@imb-cnm.csic.es
	Instituto Tecnológico de Aragón (ITAINNOVA)	farteche@itainnova.es
	Universidad de Oviedo	santiago.folgueras@cern.ch
	University of Barcelona-ICCUB	dgascon@fqa.ub.edu
FR	CEA-LETI	cedric.dehos@cea.fr
	Institut Polytechnique de Paris, CNRS-IN2P3, OMEGA	taille@in2p3.fr
	Laboratoire d'Annecy de Physique des Particules (LAPP)	Pierre.Delebecque@lapp.in2p3.fr
	Laboratoire de Physique de Clermont - LPC	lclero@cern.ch
	Laboratoire de physique nucléaire et de hautes énergies (LPNHE)	giovanni.calderini@lpnhe.in2p3.fr
	Univeristy Grenoble Alpes, CNRS, LEGI	damien.colombet@univ-grenoble-alpes.fr
	Université Aix-Marseille, CNRS-IN2P3, CPPM	legac@cppm.in2p3.fr
	Université Claude Bernard Lyon 1, CNRS-IN2P3, IP2I	d.contardo@ipnl.in2p3.fr
	Université de Strasbourg, CNRS-IN2P3, IPHC	jerome.baudot@iphc.cnrs.fr
	Université Grenoble Alpes, CNRS-IN2P3, LPSC	fmalek@psc.in2p3.fr
	Université Paris-Saclay, CEA, IRFU	florent.bouyjou@cea.fr
	Université Paris-Saclay, CNRS-IN2P3, IJClab	daniel.charlet@ijclab.in2p3.fr
IL	Tel-Aviv University	Yan.Benhammou@cern.ch
IT	INFN Pisa	Fabrizio.Palla@cern.ch
	INFN Torino	darochar@to.infn.it
	INFN-Arcadia project, represented by INFN Torino	darochar@to.infn.it
	Scuola Superiore Sant'Anna Pisa	claudio.oton@santannapisa.it
	Università degli Studi di Milano and INFN Sezione di Milano	atiilio.andreazza@mi.infn.it
	Università di Padova	piero.giubilato@unipd.it
	University of Bergamo / INFN Pavia / University of Pavia	luigi.gaioni@unibg.it
	University of Trento	philippe.velha@unitn.it
	University of Udine	stefano.saggini@uniud.it
JP	KEK, High Energy Accelerator Research Organization	kisisita@post.kek.jp
KR	Daegu Gyeongbuk Institute of Science and Technology (DGIST)	gain.kim@dgist.ac.kr
	Gangneung-Wonju National University (GWNU)	elizabeth.locci@cern.ch
NL	NIKHEF	r.kluit@nikhef.nl
NO	Norwegian Institutes (UiB, UiO, USN) represented by University of Bergen (U	johan.alme@uib.no
PL	University of Krakow AGH	Marek.Idzik@cern.ch
SE	University of Uppsala	richard.brenner@physics.uu.se
UK	Imperial College	g.iles@imperial.ac.uk
	Queen Mary University of London (QMUL)	m.bona@qmul.ac.uk
	UKRI-STFC Rutherford Appleton Laboratory (RAL)	mark.prydderch@stfc.ac.uk
	University College London (UCL)	a.korn@ucl.ac.uk
	University of Birmingham	S.J.Hillier@bham.ac.uk
	University of Bristol	David.Cussans@Bristol.ac.uk
	University of London Royal Holloway	veronique.boisvert@rhul.ac.uk
	University of Manchester	conor.fitzpatrick@cern.ch
	University of Oxford; Rutherford Appleton Laboratory	prof.jocelyn.monroe@gmail.com
	University of Warwick	karolos.potamianos@cern.ch
US	Argonne National Laboratory (ANL)	jinqiang.zhang@cern.ch
	Brookhaven National Laboratory (BNL)	chc@bnl.gov
	Fermilab National Laboratory (FNAL)	dbraga@fnal.gov
	Ohio State University	gan.1@osu.edu
	SLAC National Accelerator Laboratory	lorenzor@slac.stanford.edu
	University of Boston	angelo.giacomo.zecchinelli@cern.ch
	University of Minnesota	rusack@umn.edu

The Steering Committee

The Central Executive Body of DRD7

- Current structure: 6 members. Chaired by two co-chairs elected from within the committee.
- Has evolved out of R&D roadmap TF7 membership by ad-hoc appointments.
Primary motivation for current composition: Representation of major national communities / centers, diversity of expertise, ensuring continuity with roadmap recommendations.
- After proposal phase: 4 - 8 members, elected by Collaboration Board. Chaired by Spokesperson and Deputy Spokesperson - nominated from within the committee, endorsed by Collaboration Board.

Current composition:

- Frank Simon [KIT] (co-chair)
- Francois Vasey [CERN] (co-chair)
- Jerome Baudot [IPHC Strasbourg]
- Marcus French [STFC RAL]
- Ruud Kluit [NIKHEF]
- Angelo Rivetti [INFN TO]

Main roles:

- Oversees activities and progress of WPs
- Prepares annual report and workshop
- Nominates Spokesperson, Deputy Spokesperson, WP Conveners

Together with WG Conveners: ***Technical Committee***

- Progress tracking and reviewing of projects
- Proposes new Projects to Collaboration Board
- Oversight of DRD7 presentations and publications
(detailed procedures to be worked out)

The Work Packages

Addressing Roadmap DRDTs, hosting Projects

		DRDT
Data density	High data rate ASICs and systems	7.1
	New link technologies (fibre, wireless, wireline)	7.1
	Power and readout efficiency	7.1
Intelligence on the detector	Front-end programmability, modularity and configurability	7.2
	Intelligent power management	7.2
	Advanced data reduction techniques (ML/AI)	7.2
4D-techniques	High-performance sampling (TDCs, ADCs)	7.3
	High precision timing distribution	7.3
	Novel on-chip architectures	7.3
Extreme environments and longevity	Radiation hardness	7.4
	Cryogenic temperatures	7.4
	Reliability, fault tolerance, detector control	7.4
	Cooling	7.4
Emerging technologies	Novel microelectronic technologies, devices, materials	7.5
	Silicon photonics	7.5
	3D-integration and high-density interconnects	7.5
	Keeping pace with, adapting and interfacing to COTS	7.5

- With slight remapping of activities to maximize synergies within working groups
- Complex monolithic sensors / ASICs added in area of emerging technologies (overlap with DRD3 resolved)
- Backend systems & COTS as an independent topic
- Transverse WG on Tools and Technologies

The Work Packages

Addressing Roadmap DRDTs, hosting Projects

		DRDT			
Data density	High data rate ASICs and systems	7.1		WG 7.7 Tools and Technologies	
	New link technologies (fibre, wireless, wireline)	7.1			• WP 7.1 - Data Density and Power Efficiency
	Power and readout efficiency	7.1			
Intelligence on the detector	Front-end programmability, modularity and configurability	7.2			• WP 7.2 - Intelligence on the Detector
	Intelligent power management	7.2			
	Advanced data reduction techniques (ML/AI)	7.2			• WP 7.3 - 4D and 5D Techniques
4D-techniques	High-performance sampling (TDCs, ADCs)	7.3			• WP 7.4 - Extreme Environments
	High precision timing distribution	7.3			• WP 7.5 - Backend Systems and commercial off-the-shelf Components
	Novel on-chip architectures	7.3			• WP 7.6 - Complex imaging ASICs and Technologies
Extreme environments and longevity	Radiation hardness	7.4			
	Cryogenic temperatures	7.4			
	Reliability, fault tolerance, detector control	7.4			
	Cooling	7.4			
Emerging technologies	Novel microelectronic technologies, devices, materials	7.5			
	Silicon photonics	7.5			
	3D-integration and high-density interconnects	7.5			
	Keeping pace with, adapting and interfacing to COTS	7.5			

topics currently not explicitly addressed by projects

- With slight remapping of activities to maximize synergies within working groups
- Complex monolithic sensors / ASICs added in area of emerging technologies (overlap with DRD3 resolved)
- Backend systems & COTS as an independent topic
- Transverse WG on Tools and Technologies

The WG Conveners

Coordinating the Execution of the Scientific Program

- WP 7.1 - Data Density and Power Efficiency
Szymon Kulis [CERN], Jeffrey Prinzie [KU Leuven], Jan Troska [CERN]
 - WP 7.2 - Intelligence on the Detector
Davide Ceresa [CERN], Francesco Crescioli [LPNHE]
 - WP 7.3 - 4D and 5D Techniques
Sophie Baron [CERN], Marek Idzik [Krakow]
 - WP 7.4 - Extreme Environments
Giulio Borghello [CERN], Manuel Da Rocha Rolo [INFN TO], Oscar Augusto De Aguiar Francisco [Manchester]
 - WP 7.5 - Backend Systems and commercial off-the-shelf Components
Conor Fitzpatrick [Manchester], Niko Neufeld [CERN]
 - WP 7.6 - Complex imaging ASICs and Technologies
Marlon Barbero [CPPM], Michele Caselle [KIT], Ian Sedgwick [STFC RAL], Walter Snoeys [CERN]
 - WG 7.7 - Tools and Technologies
Kostas Kloukinas [CERN], Xavi Llopart Cudie [CERN], Mark Willoughby [STFC RAL]
- Ad-hoc appointments, based on expertise, coverage of community, involvement in relevant R&D projects.

Transition out of Proposal Phase

In Progress - Going Step by Step

- Following approval in June 2024: Establish central collaboration bodies.
 - **Collaboration Board** in operation - Chair to be elected -> See presentation of candidates
 - Call for nominations of **Steering Committee** members - expect majority of current SC members would be willing to serve for at least one more year, new nominations very welcome.
 - Election of Steering Committee members by Collaboration Board.
 - Steering Committee will propose **Work Package Conveners**, to be endorsed by Collaboration Board. Expect that majority of current WP Conveners would be willing to serve for at least one more year. Steering Committee will propose Spokesperson and Deputy Spokesperson for endorsement.
- Expected terms of office:
 - 3 years for SC members, renewable once.
Desirable to rotate and renew the committee: 2 new members per year.
 - 1 year for Spokesperson and Deputy, renewable.
- Once all collaboration bodies are established and legitimized, the yearly rolling replacement of Steering Committee members (elected by CB) will enter into effect, ensuring both broad community representation and continuity.

Going Forward

The next Steps

- **Immediate:** Election of CB chair. Online election - after the introduction of candidates later in this session.
- **After that:** Formal establishment of all collaboration bodies - see slide 7. Volunteers wanted!

- **Operational aspects:** Establish and streamline interfaces to community: web page, egroups. See next presentation, help and ideas very welcome!

- **Formal resource aspects:** Preparation, then signature of MoU. Still work in progress at CERN. Expect “financial granularity” on the level of projects.
Will also need a *Resource Manager*, annual meetings of the *Finance Review Committee* from 2025.

- **Evolution of DRD7:**
 - Growing the collaboration: New members, new projects - with the goal of also addressing roadmap topics currently not covered (for example system aspects of power distribution and data concentration).
 - Establish ways to use DRD7 expertise to support the development of DAQ concepts to guide subsystem electronics developments for future large experiments